

thin film chip fuse





dimensions and construction



ordering information

features

- Small, lightweight design
- Special manufacturing method stabilizing fusing characteristics and occupying less area
- Low power consumption and less voltage drop due to low internal resistance
- Suitable for overcurrent protection of circuit block in electronic devices
- · Suitable for flow and reflow soldering
- Products meet EU RoHS requirements

Туре	Dimensions inches (<i>mm</i>)					
(Inch Size Code)	L	W	с	d	t	
TF10BN	.04±.004	.02±.002	.008±.004	.01±.004	.015±.002	
(0402)	(1.0±0.1)	(0.5±0.05)	(0.2±0.1)	(0.25±0.1)	(0.4±0.05)	
TF16AT	.063±.004	.031±.003	.012±.004	.012±.004	.018±.002	
(0603)	(1.6±0.1)	(0.8±0.08)	(0.3±0.1)	(0.3±0.1)	(0.45±0.05)	
TF16SN	.063±.008	.031±.004	.012±.004	.012±.004	$.015+ +.004 \\002 \\ (0.4+ +0.1 \\ -0.05)$	
(0603)	(1.6±0.2)	(0.8±0.1)	(0.3±0.1)	(0.3±0.1)		

TF	16S	N 1.25		Т	TD	
Туре	Size	Fusing Characteristic	Rated Current	Termination Material	Packaging	
	10B: 0402	N: Normal blow	Reference	T: Sn	TB: 2mm pitch punched paper	
	16A: 0603	T: Anti pulse	rating chart		(TF10BN only, 10,000 pieces/reel)	
	16S: 0603	(16A only)			TD: 4mm pitch punched paper	
					(TF16 only, 5,000 pieces/reel)	

applications and ratings

Part Designation	Marking	Rated Current	Fusing Time	Internal R. Maximum (mΩ)	Rated Voltage	Rated Ambient Temperature	Operating Temperature Range
TF10BN0.20	А	0.20A		1990			
TF10BN0.25	С	0.25A		1270			
TF10BN0.315	D	0.315A		850			
TF10BN0.50	F	0.50A		320			
TF10BN0.63	Í	0.63A	Open within	200			
TF10BN0.80	K	0.80A	5 sec. at 200%	135			
TF10BN1.00	L	1.00A	rated current	115	DC		-55°C
TF10BN1.25	М	1.25A	(Refer to Fusing	90	32V	+70°C	to
TF10BN1.60	N	1.60A	Characteristics	58			+125°C
TF10BN2.00	S	2.00A	aranh)	42			
TF10BN2.50	Т	2.50A	graphy	35			
TF10BN3.00	V	3.00A		30			
TF10BN3.50	R	3.50A		27			
TF10BN4.00	Х	4.00A		23			
TF10BN5.00	Y	5.00A		19			
TF16AT0.25	С	0.25A		498			
TF16AT0.315	D	0.315A		384			
TF16AT0.50	F	0.50A	Open within	198			
TF16AT0.63	Í	0.63A	5 sec. at 200%	143			5500
TF16AT0.80	K	0.80A	rated current	120	DC	170°C	-55°C
TF16AT1.00	L	1.00A	(Refer to Fusing	94	32V	+70 0	±125°C
TF16AT1.25	М	1.25A	Characteristics	73			7120 0
TF16AT1.60	N	1.60A	graph)	59			
TF16AT2.00	S	2.00A	~ • •	42			
TF16AT2.50	Т	2.50A		32			
For further information on packaging, please refer to Appendix A.							

Specifications given herein may be changed at any time without prior notice. Please confirm technical specifications before you order and/or use. 11/15/23





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applications and ratings (continued)

Part Designation	Marking	Rated Current	Fusing Time	Internal R. Maximum (mΩ)	Rated Voltage	Rated Ambient Temperature	Operating Temperature Range
TF16AT3.15	U	3.15A	Open within 5 sec. at	24			-55°C
TF16AT4.00	Х	4.00A	(Refer to Fusing	17	32V	+70°C	to
TF16AT5.00	Y	5.00A	Characteristics graph)	14			+125°C
TF16SN0.20	А	0.20A		1500			
TF16SN0.25	С	0.25A		960			
TF16SN0.315	D	0.315A		600			
TF16SN0.40	Н	0.40A	Opon within	440			
TF16SN0.50	E E	0.50A	1 soc at 200%	300			
TF16SN0.63		0.63A	rated current	190			-40°C
TF16SN0.70	J	0.70A	(Pofor to Eusing	170	32V	+70°C	10
TF16SN0.80	K	0.80A	Characteristics	135			+125°C
TF16SN1.00	L	1.00A	(ranh)	103			
TF16SN1.25	М	1.25A	graph	78			
TF16SN1.60	N	1.60A		58			
TF16SN2.00	S	2.00A		47			
TF16SN2.50	T	2. <u>5</u> 0A		<u>3</u> 8			
TF16SN3.15	U	3.15A		28			

environmental applications

Derating Curve



Stationary Current: Regard the peak of stationary current waveform as stationary current value when the stationary current is repeated pulse.

Temperature Derating: Rated current needs to be derated if used at an ambient temperature $70^{\circ}C$ or above. Refer to the derating coefficient on the left figure.

TF10BN 204 25A 315A 5A 40A 8A 1A128A16A 3A 25A 3A 35A 4A 5A 10 1 1 1.1





Fusing Current (A) Performance Characteristics

	Require	ment			
Parameter	Limit	Typical	Test Method		
Fusing Characteristics	Within 1 second (16SN) Within 5 seconds (10BN, 16AT)	-	200% of rated voltage shall be carried (@25°C)		
Bending Test	No mechanical damages	_	Distance between holding points: 90mm, Bending: 3mm, 1 time (BN, AT), 2mm, 1 time (SN)		
Resistance to Solder Heat	±10%	±4.5% (16SN) ±5% (10BN, 16AT)	$260^{\circ}C \pm 5^{\circ}C$, 10 seconds $\pm 0.5^{1}_{0}$ second		
Solderability	95% coverage minimum	—	$245^{\circ}C \pm 3^{\circ}C$, 3 seconds ± 0.5 second		
Load Life	±10%	±4.5%(16SN) ±5% (10BN, 16AT)	$70^{\circ}C \pm 2^{\circ}C$, 1000 hours, rated current x 100%, 1.5 hr ON, 0.5 hr OFF cycle		
Load Life Moisture	±10%	±3% (10BN) ±4.5% (16SN), 5% (16AT)	40°C ± 2°C, 90 - 95% RH, 1000 hours, rated current x 100% (10BN, 16SN), x 75% (16AT), 1.5 hr ON, 0.5 hr OFF cycle		
Rapid Change of Temperature	±10%	±4% (16SN) ±5% (10BN, 16AT)	16SN: -40°C \pm 2°C (30 minutes), 10BN, 16AT: -55°C \pm 2°C, +125°C (30 minutes), 10 cycles		
Resistance to Solvent	No evidence of damages to protective coating and marking	_	Conforming to MIL-STD-202F		
Residual Resistance	10kΩ and more	_	Measure DC resistance after fusing		
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